

Description

The HM6N15D uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

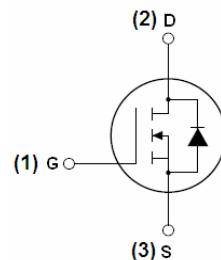
- $V_{DS} = 150V, I_D = 6A$
- $R_{DS(ON)} < 300m\Omega @ V_{GS}=10V$ (Typ:70m Ω)
- High density cell design for ultra low $R_{DS(on)}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

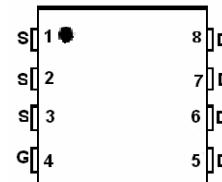
- Boost converters
- LED backlighting
- Uninterruptible power supply

100% UIS TESTED!

100% ΔV_{ds} TESTED!



Schematic diagram



Marking and pin assignment

Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|---------|----------------|-----------|------------|----------|
| HM6N15D | HM6N15D | DFN5X6-8L | - | - | - |

Absolute Maximum Ratings ($T_c=25^\circ C$ unless otherwise noted)

| Symbol | Parameter | Limit | Unit |
|---------------------|---|------------|---------------|
| V_{DS} | Drain-Source Voltage | 150 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | V |
| I_D | Drain Current-Continuous | 6 | A |
| $I_D (100^\circ C)$ | Drain Current-Continuous($T_c=100^\circ C$) | 4.2 | A |
| I_{DM} | Pulsed Drain Current | 18 | A |
| P_D | Maximum Power Dissipation | 75 | W |
| | Derating factor | 0.5 | W/ $^\circ C$ |
| E_{AS} | Single pulse avalanche energy ^(Note 5) | 200 | mJ |
| T_J, T_{STG} | Operating Junction and Storage Temperature Range | -55 To 175 | $^\circ C$ |

Thermal Characteristic

| | | | |
|-----------------|--|-----|--------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case ^(Note 2) | 2.0 | $^\circ C/W$ |
|-----------------|--|-----|--------------|

Electrical Characteristics ($T_c=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Condition | Min | Typ | Max | Unit |
|--|---|--|-----|------|-----------|------------------|
| Off Characteristics | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$ | 150 | 165 | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $\text{V}_{\text{DS}}=150\text{V}, \text{V}_{\text{GS}}=0\text{V}$ | - | - | 1 | μA |
| I_{GSS} | Gate-Body Leakage Current | $\text{V}_{\text{GS}}=\pm 20\text{V}, \text{V}_{\text{DS}}=0\text{V}$ | - | - | ± 100 | nA |
| On Characteristics ^(Note 3) | | | | | | |
| $\text{V}_{\text{GS}(\text{th})}$ | Gate Threshold Voltage | $\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$ | 1.5 | 2 | 2.5 | V |
| $\text{R}_{\text{DS}(\text{ON})}$ | Drain-Source On-State Resistance | $\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=10\text{A}$ | - | 260 | 300 | $\text{m}\Omega$ |
| g_{FS} | Forward Transconductance | $\text{V}_{\text{DS}}=5\text{V}, \text{I}_D=10\text{A}$ | - | 20 | - | S |
| Dynamic Characteristics ^(Note 4) | | | | | | |
| C_{iss} | Input Capacitance | $\text{V}_{\text{DS}}=25\text{V}, \text{V}_{\text{GS}}=0\text{V},$ $F=1.0\text{MHz}$ | - | 2000 | - | PF |
| C_{oss} | Output Capacitance | | - | 290 | - | PF |
| C_{rss} | Reverse Transfer Capacitance | | - | 180 | - | PF |
| Switching Characteristics ^(Note 4) | | | | | | |
| $t_{\text{d}(\text{on})}$ | Turn-on Delay Time | $\text{V}_{\text{DD}}=75\text{V}, \text{R}_{\text{L}}=5\Omega$ $\text{V}_{\text{GS}}=10\text{V}, \text{R}_{\text{GEN}}=3\Omega$ | - | 10.5 | - | nS |
| t_r | Turn-on Rise Time | | - | 5.5 | - | nS |
| $t_{\text{d}(\text{off})}$ | Turn-Off Delay Time | | - | 14.5 | - | nS |
| t_f | Turn-Off Fall Time | | - | 3 | - | nS |
| Q_g | Total Gate Charge | $\text{V}_{\text{DS}}=75\text{V}, \text{I}_D=10\text{A},$ $\text{V}_{\text{GS}}=10\text{V}$ | - | 17 | - | nC |
| Q_{gs} | Gate-Source Charge | | - | 4 | - | nC |
| Q_{gd} | Gate-Drain Charge | | - | 4.4 | - | nC |
| Drain-Source Diode Characteristics | | | | | | |
| V_{SD} | Diode Forward Voltage ^(Note 3) | $\text{V}_{\text{GS}}=0\text{V}, \text{I}_s=8\text{A}$ | - | - | 1.2 | V |
| I_s | Diode Forward Current ^(Note 2) | - | - | - | 6 | A |
| t_{rr} | Reverse Recovery Time | $\text{TJ} = 25^\circ\text{C}, \text{IF} = 10\text{A}$ $\text{di/dt} = 100\text{A}/\mu\text{s}$ ^(Note 3) | - | 32 | - | nS |
| Q_{rr} | Reverse Recovery Charge | | - | 53 | - | nC |
| t_{on} | Forward Turn-On Time | Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD) | | | | |

Notes:

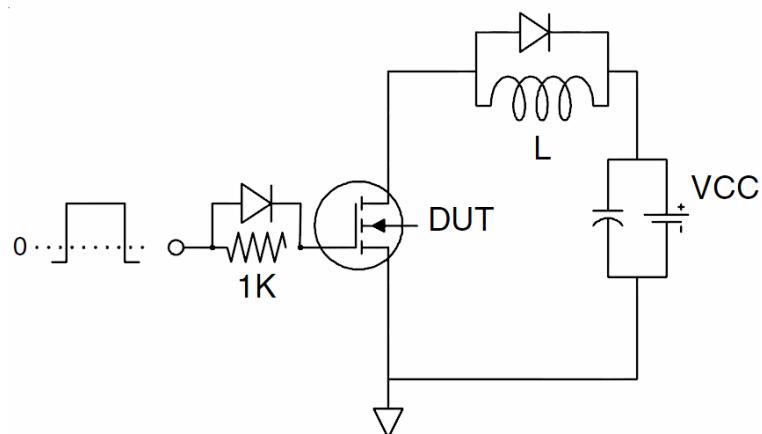
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production
5. EAS condition: $\text{Tj}=25^\circ\text{C}, \text{V}_{\text{DD}}=50\text{V}, \text{V}_{\text{G}}=10\text{V}, \text{L}=0.5\text{mH}, \text{R}_{\text{g}}=25\Omega$

Test Circuit

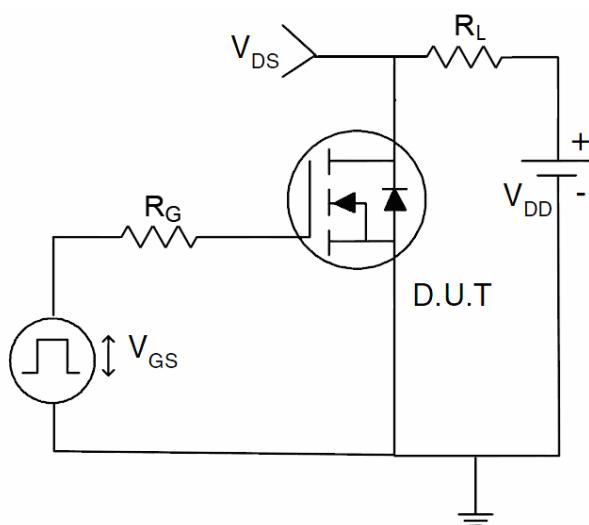
1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



3) Switch Time Test Circuit



Typical Electrical and Thermal Characteristics (Curves)

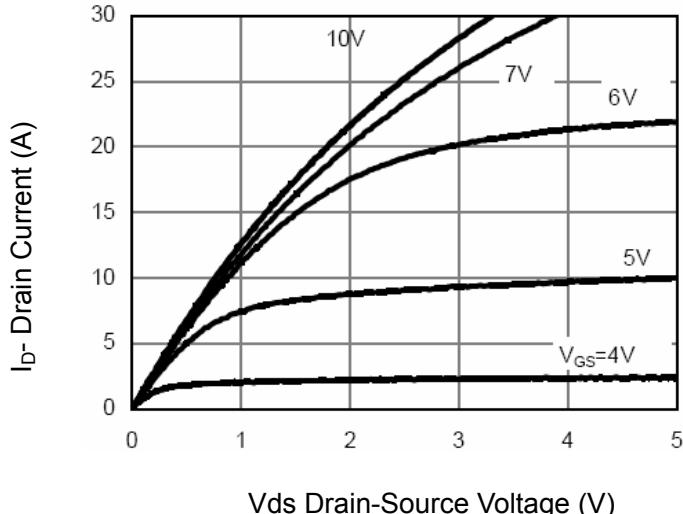


Figure 1 Output Characteristics

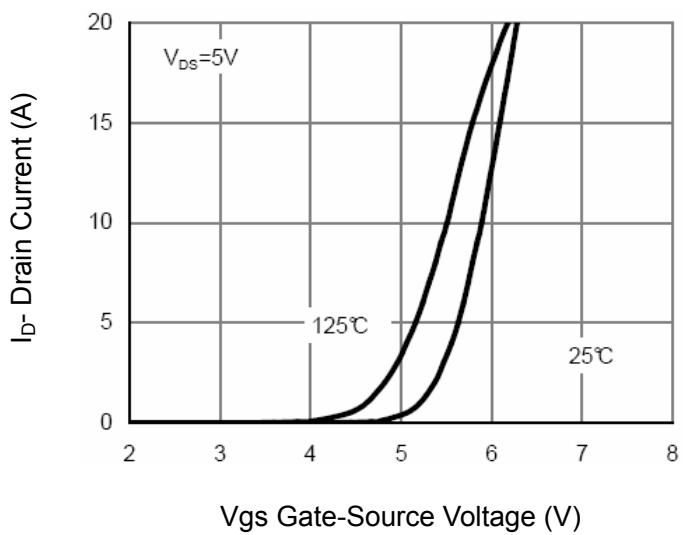


Figure 2 Transfer Characteristics

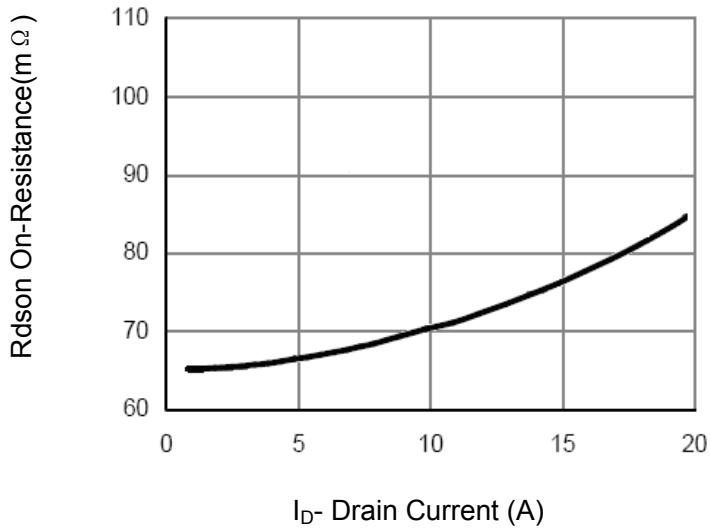


Figure 3 Rdson- Drain Current

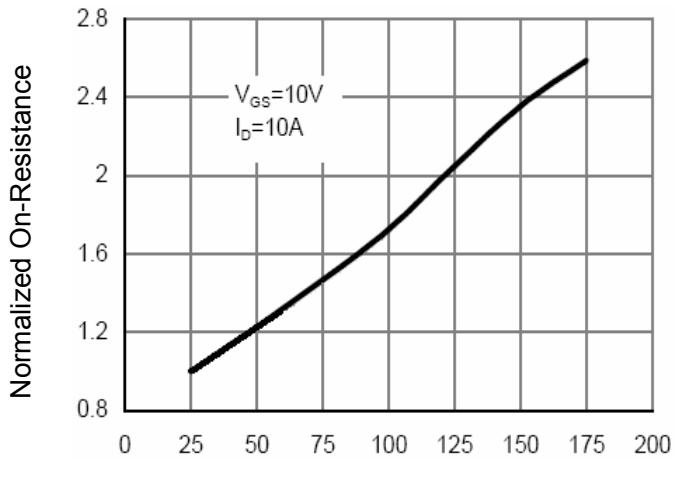


Figure 4 Rdson-JunctionTemperature

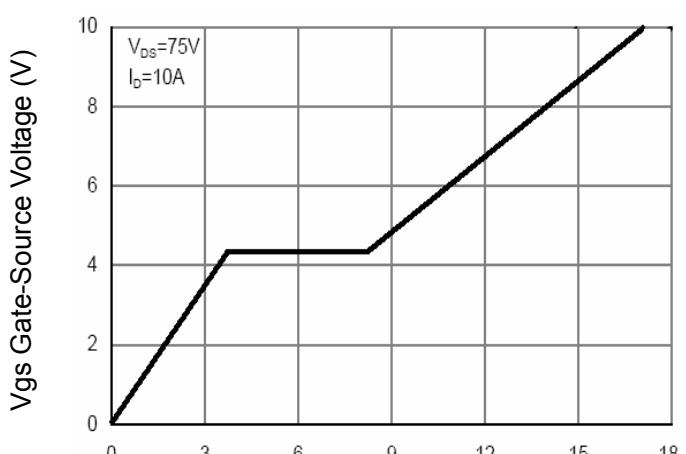


Figure 5 Gate Charge

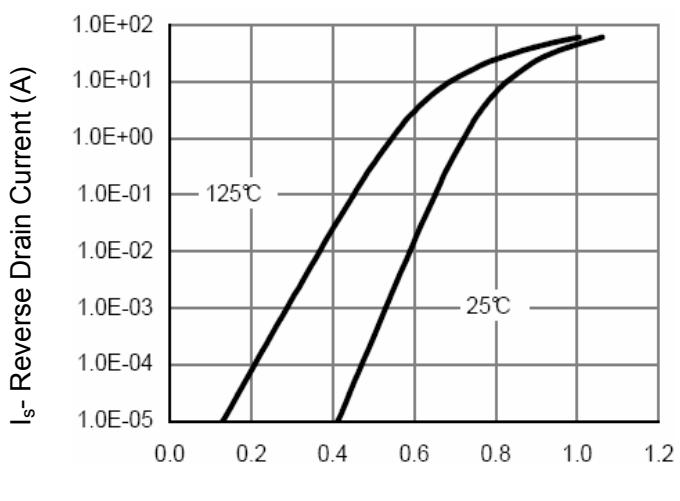


Figure 6 Source- Drain Diode Forward

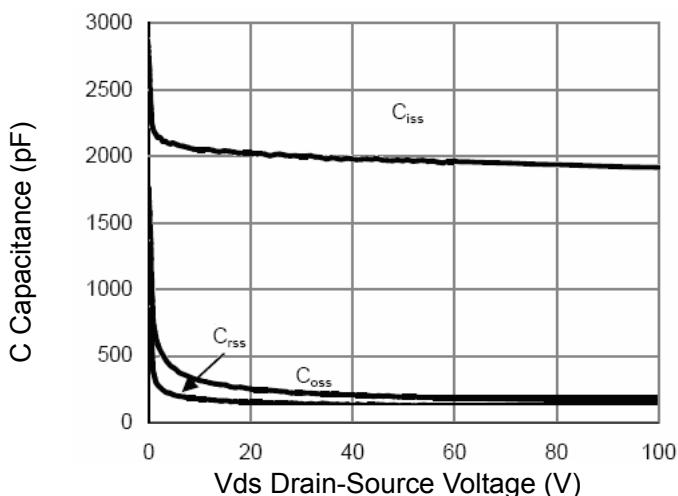


Figure 7 Capacitance vs Vds

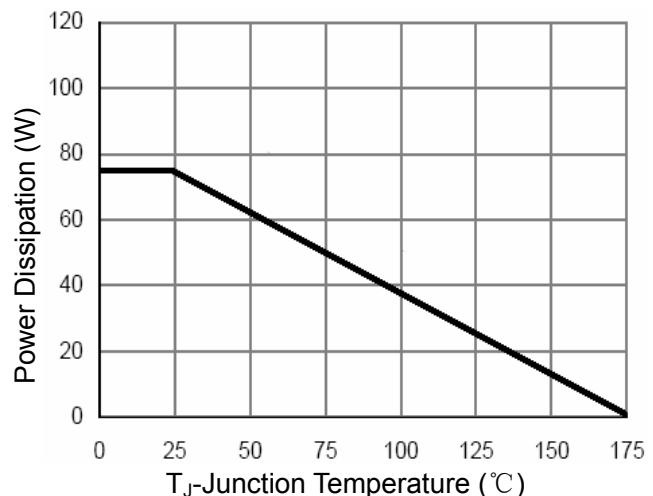


Figure 9 Power De-rating

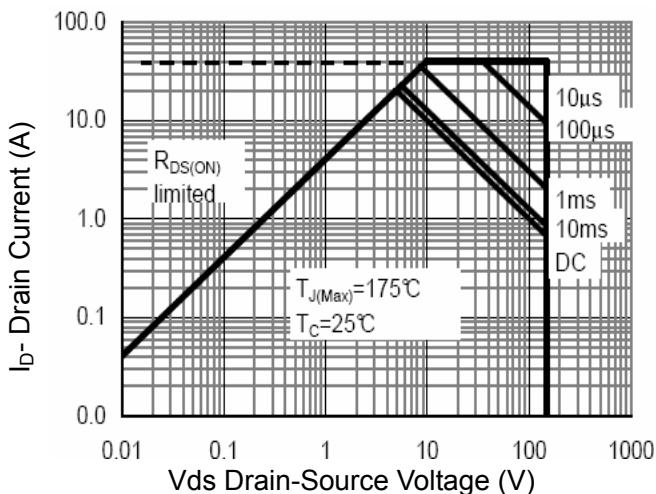


Figure 8 Safe Operation Area

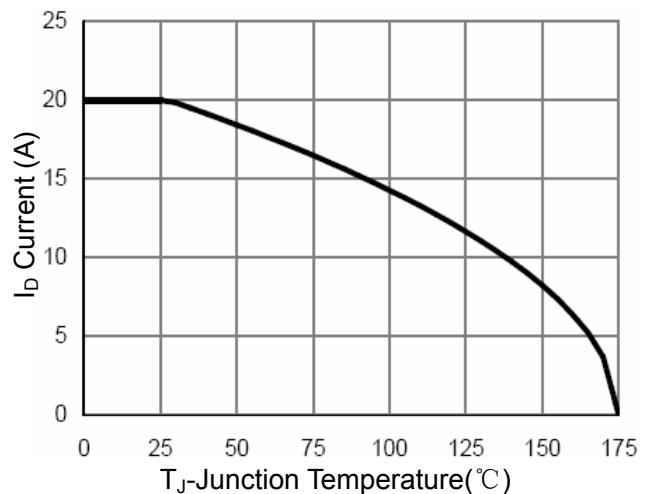


Figure 10 ID Current- Junction Temperature

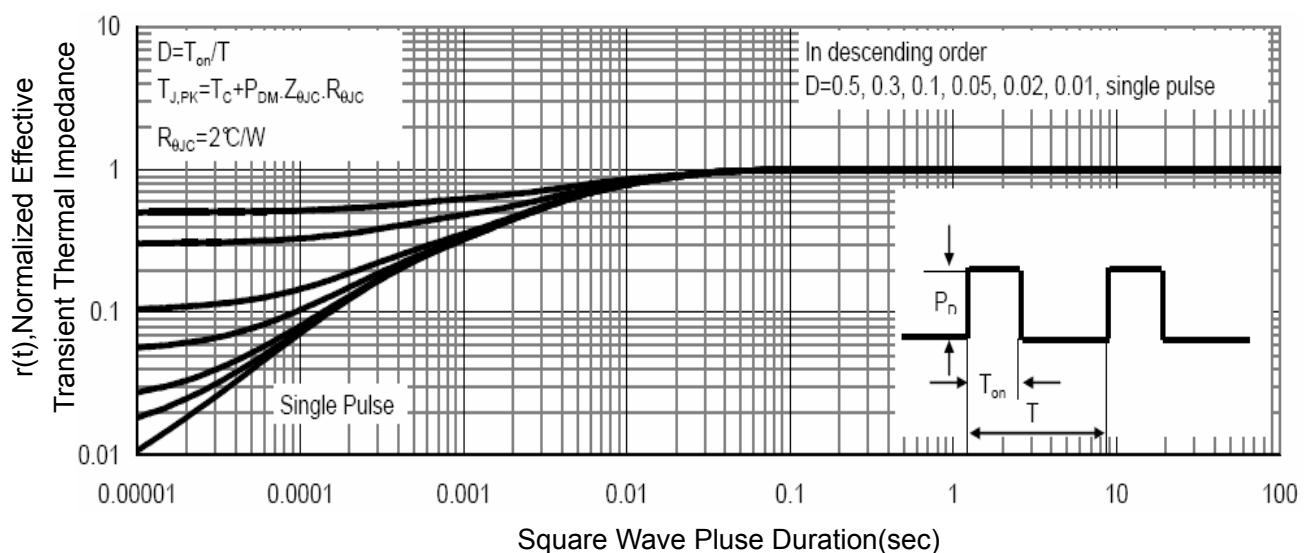
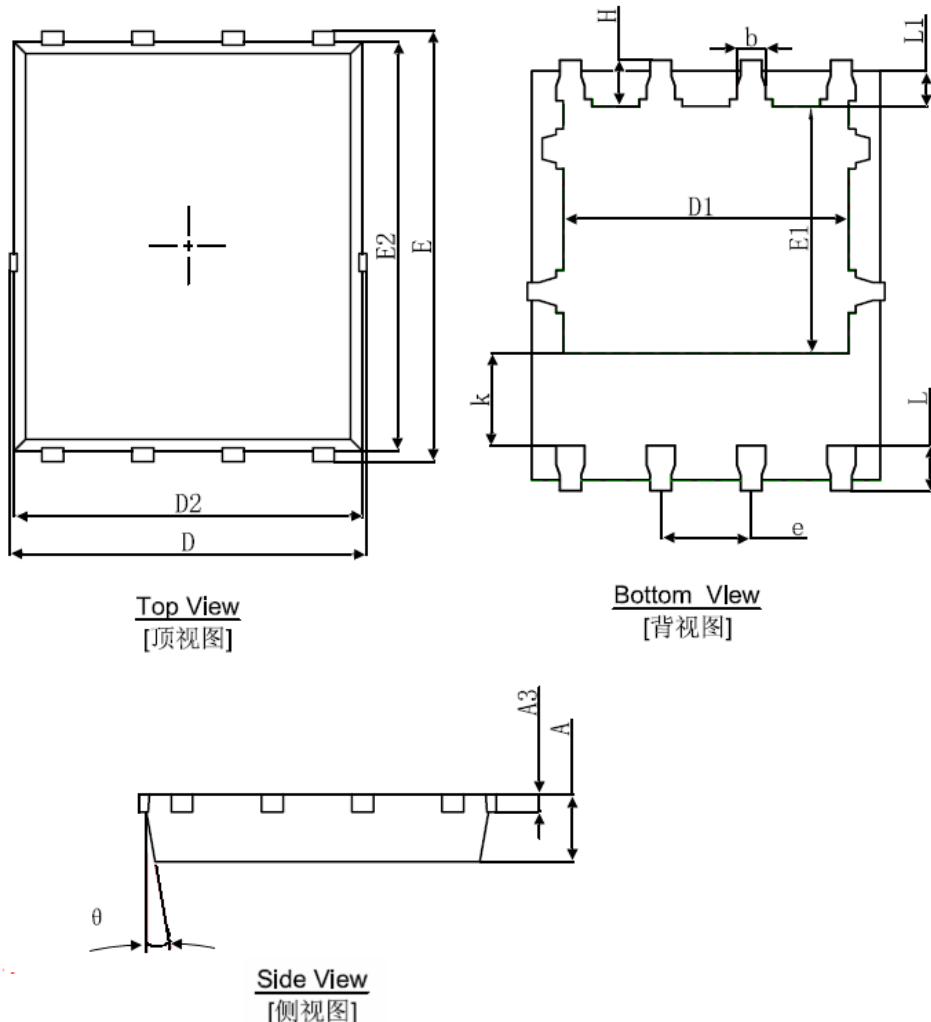


Figure 11 Normalized Maximum Transient Thermal Impedance

DFN5X6-8L Package Information



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 0.900 | 1.000 | 0.035 | 0.039 |
| A3 | 0.254REF. | | 0.010REF. | |
| D | 4.944 | 5.096 | 0.195 | 0.201 |
| E | 5.974 | 6.126 | 0.235 | 0.241 |
| D1 | 3.910 | 4.110 | 0.154 | 0.162 |
| E1 | 3.375 | 3.575 | 0.133 | 0.141 |
| D2 | 4.824 | 4.976 | 0.190 | 0.196 |
| E2 | 5.674 | 5.826 | 0.223 | 0.229 |
| k | 1.190 | 1.390 | 0.047 | 0.055 |
| b | 0.350 | 0.450 | 0.014 | 0.018 |
| e | 1.270TYP. | | 0.050TYP. | |
| L | 0.559 | 0.711 | 0.022 | 0.028 |
| L1 | 0.424 | 0.576 | 0.017 | 0.023 |
| H | 0.574 | 0.726 | 0.023 | 0.029 |
| θ | 8° | | 8° | |